

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

www.ti.com

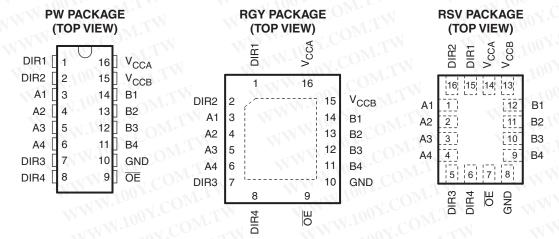
SCES693B-FEBRUARY 2008-REVISED MAY 2008

# 4-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

#### FEATURES

- Each Channel Has an Independent DIR Control Input
- Control Inputs V<sub>IH</sub>/V<sub>IL</sub> Levels Are Referenced to V<sub>CCA</sub> Voltage
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I/Os Are 4.6-V Tolerant
- I<sub>off</sub> Supports Partial Power-Down-Mode Operation
- Typical Data Rates
  - 380 Mbps (1.8-V to 3.3-V Translation)
  - 200 Mbps (<1.8-V to 3.3-V Translation)
  - 200 Mbps (Translate to 2.5 V or 1.8 V)
  - 150 Mbps (Translate to 1.5 V)
  - 100 Mbps (Translate to 1.2 V)

- Latch-Up Performance Exceeds 100 mA Per JESD 78. Class II
- ESD Protection Exceeds the Following Levels (tested per JESD 22)
  - 8000-V Human-Body Model (A114-A)
  - 250-V Machine Model (A115-A)
  - 1500-V Charged-Device Model (C101)



#### DESCRIPTION/ORDERING INFORMATION

This 4-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 1.2 V to 3.6 V. The SN74AVC4T774 is optimized to operate with  $V_{CCA}/V_{CCB}$  set at 1.4 V to 3.6 V. It is operational with  $V_{CCA}/V_{CCB}$  as low as 1.2 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw



www.ti.com

SCES693B-FEBRUARY 2008-REVISED MAY 2008

# **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

The SN74AVC4T774 is designed for asynchronous communication between data buses. The logic levels of the direction-control (DIR) input and the output-enable  $(\overline{OE})$  input activate either the B-port outputs or the A-port outputs or place both output ports in the high-impedance mode. The device transmits data from the A bus to the B bus when the B outputs are activated, and from the B bus to the A bus when the A outputs are activated. The input circuitry on both A and B ports is always active and must have a logic HIGH or LOW level applied to prevent excess  $I_{CC}$  and  $I_{CCZ}$ .

The SN74AVC4T774 is designed so that the control pins (DIR1, DIR2, DIR3, DIR4, and  $\overline{\text{OE}}$ ) are supplied by  $V_{\text{CCA}}$ .

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The  $V_{CC}$  isolation feature ensures that if either  $V_{CC}$  input is at GND, then both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CCA}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Since this device has CMOS inputs, it is very important to not allow them to float. If the inputs are not driven to either a high  $V_{CC}$  state, or a low GND state, an undesirable larger than expected  $I_{CC}$  current may result. Since the input voltage settlement is governed by many factors (e.g. capacitance, board-layout, package inductance, surrounding conditions, etc.), ensuring that they these inputs are kept out of erroneous switching states and tying them to either a high or a low level minimizes the leakage-current.

#### **ORDERING INFORMATION**

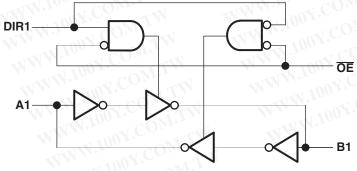
T <sub>A</sub>	PAC	KAGE <sup>(1)(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
MA.	QFN – RGY	Tape and reel	SN74AVC4T774RGYR	WT774
4000 1- 0500	QFN - RSV	Tape and reel	SN74AVC4T774RSVR	ZVK
–40°C to 85°C	TOOOD DIV	Tube	SN74AVC4T774PW	W
	TSSOP – PW	Tape and reel	SN74AVC4T774PWR	WT774

- (1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.
- (2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

# FUNCTION TABLE (Each Bit)

CONTRO	L INPUTS	OUTPUT	CIRCUITS	ODEDATION
ŌĒ	DIR	A PORT	B PORT	OPERATION
Toh	COL	Enabled	Hi-Z	B data to A data
W 100 Y.	HALL	Hi-Z	Enabled	A data to B data
H	X	Hi-Z	Hi-Z	Isolation

# LOGIC DIAGRAM (POSITIVE LOGIC)(1)



(1) Shown for a single channel



#### TYPICAL APPLICATION

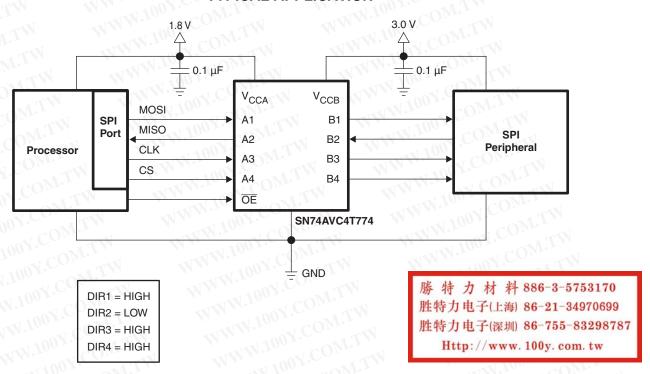


Figure 1. Typical Application of the SN74AVC4T774

# **ABSOLUTE MAXIMUM RATINGS**(1)

	MMM. OOX.CO. TW WWW.	100Y.C	MIN	MAX	UNIT
$V_{CCA}$	Supply voltage range	N.100X.COM.TW	-0.5	4.6	V
	WWW. OOX.CO. TW WW	I/O ports (A port)	-0.5	4.6	O.Y.
$V_{I}$	Input voltage range (2)	I/O ports (B port)	-0.5	4.6	٧.
	M. TW. TOO T. COM. I.	Control inputs	-0.5	4.6	.UU
Vo	Voltage range applied to any output in the high-impedance or	A port	-0.5	4.6	$100^{\circ}$
v <sub>O</sub>	power-off state (2)	B port	-0.5	4.6	1 100
Vo	Voltage range applied to any output in the high or low state (2)(3)	A port	-0.5	V <sub>CCA</sub> + 0.5	V
۷O	voltage range applied to any output in the high or low state	B port	-0.5	$V_{CCB} + 0.5$	M.Yu
l <sub>IK</sub>	Input clamp current	V <sub>I</sub> < 0	TW	-50	mA
lok	Output clamp current	V <sub>0</sub> < 0	WILL	-50	mA
lo	Continuous output current	WWW.IOV.CO	NI.	±50	mA
	Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND	W.100 -	$M_{r_r}$	±100	mA
T <sub>stq</sub>	Storage temperature range.	11007.0	-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Copyright © 2008, Texas Instruments Incorporated

The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

SCES693B-FEBRUARY 2008-REVISED MAY 2008

力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www. 100y. com. tw



www.ti.com

### PACKAGE THERMAL IMPEDANCE

COM.	INW.100 CO	M. I. CO.	NI.	UNIT
1.00	TW 1001.	PW package <sup>(1)</sup>	108	
$\theta_{JA}$	Package thermal impedance	RGY package <sup>(2)</sup>	39	°C/W
COI	M. WWW. Took.	RSV package <sup>(1)</sup>	184	

- The package thermal impedance is calculated in accordance with JESD 51-7.
- The package thermal impedance is calculated in accordance with JESD 51-5. (2)

# RECOMMENDED OPERATING CONDITIONS (1)(2)(3)

1 100	T.MO	W. 100 r.	V <sub>CCI</sub>	V <sub>cco</sub>	MIN MAX	UNIT
$V_{CCA}$	Supply voltage	1100	TIME	N. A.	1.2 3.6	V
V <sub>CCB</sub>	Supply voltage	N WWW.	CO" TW	MM	1.2 3.6	V
TW.	ON.	TANN TOO	1.2 V to 1.95 V	WW	V <sub>CCI</sub> × 0.65	
$V_{IH}$	High-level input voltage	Data inputs (4)	1.95 V to 2.7 V		1.6	V
	input voltage	TN WN	2.7 V to 3.6 V		2	
TWV	COM	THE WINN.	1.2 V to 1.95 V	W WY	V <sub>CCI</sub> × 0.35	
$V_{IL}$	Low-level input voltage	Data inputs <sup>(4)</sup>	1.95 V to 2.7 V	-31	0.7	V
	input voltage	M.TW WY	2.7 V to 3.6 V	1, , , , , , , , , , , , , , , , , , ,	0.8	-T
W	AM. CO	DIR	1.2 V to 1.95 V	IN 1	$V_{CCA} \times 0.65$	111
$V_{IH}$	High-level input voltage	(referenced to V <sub>CCA</sub> ) <sup>(5)</sup>	1.95 V to 2.7 V	W	1.6	V
	input voltage	(DIRx, OE)	2.7 V to 3.6 V	1.1	2 COM	- XX
	1007.	DIR	1.2 V to 1.95 V	$M.I{M}$	$V_{CCA} \times 0.35$	1.1
$V_{IL}$	Low-level input voltage	(referenced to V <sub>CCA</sub> ) <sup>(5)</sup>	1.95 V to 2.7 V	WITT	0.7	V
	input voltage	(DIRx, OE)	2.7 V to 3.6 V	ON	0.8	
VI	Input voltage	COMITY	W.100	OM	0 3.6	$D_{N}A_{n}$
.,	0.10	Active state	1007	-OW.TW	0 V <sub>cco</sub>	$OM_{ij}$
Vo	Output voltage	3-state	WWW	TW	0 3.6	V
	I.WW.I	COM	WW.io	1.1 V to 1.2 V	-3	$Co_{k}$
			W. 100	1.4 V to 1.6 V	-6	COD
$I_{OH}$	High-level output of	urrent	11/1/	1.65 V to 1.95 V	-8	mA
			WWW	2.3 V to 2.7 V	-9	JY.Co
				3 V to 3.6 V	-12	N.C
	14	M.100, COW.11		1.1 V to 1.2 V	3	<b>5</b> 7 (
				1.4 V to 1.6 V	6	$I_{00x}$
$I_{OL}$	Low-level output co	urrent	N WW	1.65 V to 1.95 V	8 117	mA
			- IV	2.3 V to 2.7 V	9	1.10
				3 V to 3.6 V	12	W.100
Δt/Δν	Input transition rise	or fall rate	IN W	1007.	5	ns/V
T <sub>A</sub>	Operating free-air	emperature	TV VI	MAN. OOT.C	<b>-40</b> 85	°C

- $V_{\text{CCI}}$  is the  $V_{\text{CC}}$  associated with the input port.
- V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.
- All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
- For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCI</sub>  $\times$  0.7 V, V<sub>IL</sub> max = V<sub>CCI</sub>  $\times$  0.3 V For V<sub>CCA</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCA</sub>  $\times$  0.7 V, V<sub>IL</sub> max = V<sub>CCA</sub>  $\times$  0.3 V WWW.100Y.COM.TW

Submit Documentation Feedback

Copyright © 2008, Texas Instruments Incorporated

www.ti.com

# ELECTRICAL CHARACTERISTICS(1)(2)(3)

over recommended operating free-air temperature range (unless otherwise noted)

	RAMETER	TEST COND	TIONS	OW.T.	V	T <sub>A</sub> = 25°C	$OM_{i,j}$	–40°C to 85	5°C	UNIT
PA	RAWETER	TEST COND	IIIONS	V <sub>CCA</sub>	V <sub>CCB</sub>	MIN TYP	MAX	MIN	MAX	UNII
×7 (	OM	$I_{OH} = -100  \mu A$	W.F	1.2 V to 3.6 V	1.2 V to 3.6 V	MM. OUT	COR	V <sub>CCO</sub> - 0.2		
		$I_{OH} = -3 \text{ mA}$	JW.100	1.2 V	1.2 V	0.95	$CO_{\overline{D}}$	-XX		
VOO		$I_{OH} = -6 \text{ mA}$	1,401,10	1.4 V	1.4 V	W. 100	<u>~</u> 0	1.05		V
V <sub>OH</sub>		$I_{OH} = -8 \text{ mA}$	$V_I = V_{IH}$	1.65 V	1.65 V	1111	Y.C	1.2		V
		$I_{OH} = -9 \text{ mA}$	of WW.	2.3 V	2.3 V	WWW	N.C	1.75		
		$I_{OH} = -12 \text{ mA}$	The same	3 V	3 V	TINN.IO	-<1 (	2.3		
-11	001.00	$I_{OL} = 100 \mu\text{A}$		1.2 V to 3.6 V	1.2 V to 3.6 V	1.10	00 r.	COMIT	0.2	
		$I_{OL} = 3 \text{ mA}$	WWW	1.2 V	1.2 V	0.25	1007	VI.IV		
W.		I <sub>OL</sub> = 6 mA	V - VV	1.4 V	1.4 V	WWW		V.COP	0.35	V
V <sub>OL</sub>		I <sub>OL</sub> = 8 mA	$V_I = V_{IL}$	1.65 V	1.65 V		1.100	T COM.	0.45	V
		$I_{OL} = 9 \text{ mA}$		2.3 V	2.3 V	N V	N.10	W.	0.55	
		I <sub>OL</sub> = 12 mA	W	3 V	3 V	MM	11	107.C	0.7	
l <sub>i</sub>	Control inputs	V <sub>I</sub> = V <sub>CCA</sub> or GND		1.2 V to 3.6 V	1.2 V to 3.6 V	±0.025	±0.25	roox.coz.	±1	μА
· XX	A an D mand	VV 0 +- 2 0	/	0 V	0 V to 3.6 V	±0.1	±1	100X.	±5	N
l <sub>off</sub>	A or B port	$V_1$ or $V_0 = 0$ to 3.6	• V	0 V to 3.6 V	0 V	±0.1	±1	· CC	±5	μА
l <sub>OZ</sub>	A or B port	$V_O = V_{CCO}$ or GNI $V_I = V_{CCI}$ or GND,	OE = V <sub>IH</sub>	3.6 V	3.6 V	±0.5	±2.5	N.100Y.C	±5	μА
		ON.		1.2 V to 3.6 V	1.2 V to 3.6 V		WV	M. J.	8	TV
$I_{CCA}$		$V_I = V_{CCI}$ or GND,	$I_O = 0$	0 V	0 V to 3.6 V	Will	4	MW.Ing	-2	μΑ
		100 X.CO		0 V to 3.6 V	0 V	WI.IV		100	8	$T.I_{V}$
	WW	N. P. CO.	TW	1.2 V to 3.6 V	1.2 V to 3.6 V	WT		111	8	- 1
$I_{CCB}$		$V_I = V_{CCI}$ or GND,	$I_O = 0$	0 V	0 V to 3.6 V	COMP		WWW.	8	μΑ
		1007.		0 V to 3.6 V	0 V	COM.I			-2	MON
I <sub>CCA</sub> ·	+ I <sub>CCB</sub>	$V_I = V_{CCI}$ or GND,	$I_0 = 0$	1.2 V to 3.6 V	1.2 V to 3.6 V	WI.Mo		11	16	μΑ
Ci	Control	V <sub>I</sub> = 3.3 V or GND	OM.T	3.3 V	3.3 V	2.5	. 1	MM	1003	pF
Cio	A or B port	$V_O = 3.3 \text{ V or GNI}$		3.3 V	3.3 V	5	N .	MA	6	pF

All unused control inputs of the device must be held at VCC or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004. (1) WW.100Y.COM.TW

特力材料886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www. 100y. com. tw

Copyright © 2008, Texas Instruments Incorporated

Submit Documentation Feedback

 $V_{CCO}$  is the  $V_{CC}$  associated with the output port.

 $V_{CCI}$  is the  $V_{CC}$  associated with the input port.



# SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V<sub>CCA</sub> = 1.2 V (unless otherwise noted) (see Figure 2)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = 1.5 V ± 0.1 V	V <sub>CCB</sub> = 1.8 V ± 0.15 V	V <sub>CCB</sub> = 2.5 V ± 0.2 V	V <sub>CCB</sub> = 3.3 V ± 0.3 V	UNIT
COMIT	(INPUT)	(OUTPUT)	TYP	TYP	TYP	TYP	TYP	
t <sub>PLH</sub>		1007	3.5	2.8	2.7	2.7	3.1	
t <sub>PHL</sub>	A	B	3.5	2.8	2.7	2.7	3.1	ns
t <sub>PLH</sub>	TW B	NWW.	3.8	3.4	3.2	3	2.9	20
t <sub>PHL</sub>	В	M A 100	3.8	3.4	3.2	3	2.9	ns
t <sub>PZH</sub>	CTV OF	110	6	4.8	4.4	5.3	9.3	
t <sub>PZL</sub>	ŌĒ	A	6	4.8	4.4	5.3	9.3	ns
t <sub>PZH</sub>	ŌĒ	В	6.7	6.7	6.6	6.7	6.6	
t <sub>PZL</sub>	M. DE	N B	6.7	6.7	6.6	6.7	6.6	ns
t <sub>PHZ</sub>	ŌĒ		4.3	3.6	3.7	3.3	4	
t <sub>PLZ</sub>	ONGE	A	4.3	3.6	3.7	3.3	4	ns
t <sub>PHZ</sub>	CONTRACT	D. STAN	4.4	4.4	4.4	4.4	4.4	
t <sub>PLZ</sub>	OE .	В	4.4	4.4	4.4	4.4	4.4	ns

### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$  (see Figure 2)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = ± 0.	= 3.3 V 3 V	UNIT
WW	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	N. P.	OM	3.1	0.3	4.4	0.2	3.9	0.1	3.6	0.1	3.9	1.1
t <sub>PHL</sub>	W.1403.	В	3.1	0.3	4.4	0.2	3.9	0.1	3.6	0.1	3.9	ns
t <sub>PLH</sub>	B 00 1	COA	2.9	0.6	5.1	0.4	4.9	0.2	4.6	0.1	4.5	01/1
t <sub>PHL</sub>	M A D	COA	2.9	0.6	5.1	0.4	4.9	0.2	4.6	0.1	4.5	ns
t <sub>PZH</sub>	<del>OE</del>	A.COM.	5.3	1.1	7.1	0.9	6.2	0.7	5.5	0.1	6.4	00
t <sub>PZL</sub>	OE 1	A	5.3	1.1	7.1	0.9	6.2	0.7	5.5	0.1	6.4	ns
t <sub>PZH</sub>	ŌĒ	DOM.	4.4	1.1	8.2	1.1	8.2	1.1	8.2	1.1	8.2	-160
t <sub>PZL</sub>	OE	BOW	4.4	1.1	8.2	1.1	8.2	1.1	8.2	1.1	8.2	ns
t <sub>PHZ</sub>	ŌĒ	COL	3.6	1.2	4.8	0.8	5.4	0.4	5.1	1	5.4	10 X.C
t <sub>PLZ</sub>	UE	100 A	3.6	1.2	4.8	0.8	5.4	0.4	5.1	1	5.4	ns
t <sub>PHZ</sub>	OF	1 100 7.	3.1	0.3	5.6	0.2	5.7	0.3	5.6	0.3	56	100 -
t <sub>PLZ</sub>	ŌĒ	В	3.1	0.3	5.6	0.2	5.7	0.3	5.6	0.3	5.6	ns

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 WWW.100Y.COM.TW Http://www.100y.com.tw

Submit Documentation Feedback

WWW.100Y.COM.TW

www.ti.com

# SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$  (see Figure 2)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1			= 1.8 V 15 V	V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = ± 0.3		UNIT
COMIT	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	^	WY Day 1	2.8	0.1	4.1	0.1	3.6	0.1	3.1	0.1	3.3	
t <sub>PHL</sub>	A	В	2.8	0.1	4.1	0.1	3.6	0.1	3.1	0.1	3.3	ns
t <sub>PLH</sub>	TVB	A	2.6	0.4	4.3	0.1	4.1	0.1	3.8	0.1	3.7	
t <sub>PHL</sub>	, I V D	A	2.6	0.4	4.3	0.1	4.1	0.1	3.8	0.1	3.7	ns
t <sub>PZH</sub>	<del>OE</del>	N. T.	5	0.8	6.7	0.6	5.8	0.4	4.8	0.3	4.6	
t <sub>PZL</sub>	OE	A	5	0.8	6.7	0.6	5.8	0.4	4.8	0.3	4.6	ns
t <sub>PZH</sub>	ŌĒ	в	3.3	0.2	6.7	0.2	6.6	0.2	6.7	0.2	6.7	
t <sub>PZL</sub>	OE	В	3.3	0.2	6.7	0.2	6.6	0.2	6.7	0.2	6.7	ns
t <sub>PHZ</sub>	ŌĒ	A	3.4	0.7	4.7	0.3	5.1	0.1	4.5	0.8	5	
t <sub>PLZ</sub>	COME	A	3.4	0.7	4.7	0.3	5.1	0.1	4.5	0.8	5	ns
t <sub>PHZ</sub>	OE	N В	2.9	0.1	5.7	0.1	5.8	0.1	5.8	0.1	5.8	
t <sub>PLZ</sub>	OE 1	В	2.9	0.1	5.7	0.1	5.8	0.1	5.8	0.1	5.8	ns

#### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (see Figure 2)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = ± 0.3		UNIT
MAN	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	N. D.	ON	2.6	0.1	3.8	0.1	3.2	0.1	2.7	0.1	2.6	1.1
t <sub>PHL</sub>	W.1407.	В	2.6	0.1	3.8	0.1	3.2	0.1	2.7	0.1	2.6	ns
t <sub>PLH</sub>	31VB	COA	2.5	0.5	3.4	0.2	3.1	0.1	2.8	0.1	2.6	·0M·
t <sub>PHL</sub>	N N D	L.COA	2.5	0.5	3.4	0.2	3.1	0.1	2.8	0.1	2.6	ns
t <sub>PZH</sub>	OE	V.CON	4.7	0.7	6.2	0.5	5.2	0.3	4.1	0.3	3.6	Co
t <sub>PZL</sub>	OE	A	4.7	0.7	6.2	0.5	5.2	0.3	4.1	0.3	3.6	ns
t <sub>PZH</sub>	ŌĒ	107. PLOM	2.3	0.4	4.5	0.4	4.5	0.4	4.5	0.4	4.5	-160
t <sub>PZL</sub>	OE	BOW	2.3	0.4	4.5	0.4	4.5	0.4	4.5	0.4	4.5	ns
t <sub>PHZ</sub>	ŌĒ	A.CO	3	0.2	4.3	0.1	4.9	0.1	4	0.7	4.3	OY.C
t <sub>PLZ</sub>	UE	100 A	3	0.2	4.3	0.1	4.9	0.1	4	0.7	4.3	ns
t <sub>PHZ</sub>	OF	N.10B	1.9	01	4.7	0.1	4.6	0.1	4.7	0.1	4.7	100 -
t <sub>PLZ</sub>	ŌĒ	BY.C	1.9	01 <	4.7	0.1	4.6	0.1	4.7	0.1	4.7	ns

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw WWW.100Y.COM.TW

Copyright © 2008, Texas Instruments Incorporated

Submit Documentation Feedback

WWW.100Y.COM.TW



# SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (see Figure 2)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.		V <sub>CCB</sub> = ± 0.5		UNIT
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	Α	Pay 1	2.5	0.1	3.6	0.1	3	0.1	2.6	0.1	2.4	
t <sub>PHL</sub>	TWA	В	2.5	0.1	3.6	0.1	3	0.1	2.6	0.1	2.4	ns
t <sub>PLH</sub>	В	A	2.6	0.5	3.4	0.2	2.9	0.1	2.5	0.1	2.3	ns
t <sub>PHL</sub>	I. I D	A	2.6	0.5	3.4	0.2	2.9	0.1	2.5	0.1	2.3	115
t <sub>PZH</sub>	ŌĒ	A	4.5	0.9	5.9	0.5	5	0.3	3.8	0.3	3.3	
t <sub>PZL</sub>	OE.		3.8	0.9	5.9	0.5	5	0.3	3.8	0.3	3.3	ns
t <sub>PZH</sub>	<u>OE</u>	В	1.9	0.4	3.6	0.4	3.6	0.4	3.6	0.4	3.6	ns
t <sub>PZL</sub>	ON	В	1.9	0.4	3.6	0.4	3.6	0.4	3.6	0.4	3.6	115
t <sub>PHZ</sub>	ŌĒ	Α	2.7	0.1	4.2	0.1	4.6	0.3	3.8	0.7	3.9	ns
t <sub>PLZ</sub>	COOL	N ^	2.7	0.1	4.2	0.1	4.6	0.3	3.8	0.7	3.9	115
t <sub>PHZ</sub>	<del>OE</del>	В	2.3	0.1	4.5	0.1	4.5	0.1	4.6	0.1	4.6	ns
t <sub>PLZ</sub>	J. OL	В	2.3	0.1	4.5	0.1	4.5	0.1	4.6	0.1	4.6	110

# **OPERATING CHARACTERISTICS**

V	PARAMETER		TEST CONDITIONS	$V_{CCA} = V_{CCB} = 1.2 V$	$V_{CCA} = V_{CCB} = 1.5 V$	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.8 V	$V_{CCA} = V_{CCB} = 2.5 V$	$V_{CCA} = V_{CCB} = 3.3 V$	UNIT
1	MAN	100Y.C	CONDITIONS	TYP	TYP	TYP	TYP	TYP	LTV
	A to B	Outputs enabled	COMITY	3	3	3	3	1004	M.T
<b>(</b> 1)	A to B	Outputs disabled	$C_L = 0,$	1	W.101 Y.C	OM-TW	2	V.102	OM:
PpdA (1)	B to A		$f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$	12	13	CO 14	15	17	pF
		MY.COM. T	2	2 00	CO 2	2	2	CO	
		Outputs enabled	100X.COM.	12	13	14	16	17 100	N.CC 10Y.C
<b>(</b> 1)	A to B	Outputs disabled	$C_L = 0,$	2	2	20M.	2	2	
PpdB (1)	D to A	Outputs enabled	f = 10  MHz, $t_r = t_f = 1 \text{ ns}$	3	3	3.OM	3	4	pF
	B to A	Outputs disabled	141.100 X.CC	N. TIV	1 111	11001.COD	2	2	100

<sup>(1)</sup> Power dissipation capacitance per transceiver

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 WWW.100Y.COM.TW Http://www. 100y. com. tw WWW.100Y.COM.TW

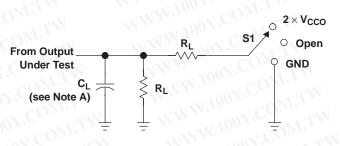
Y.COM.TW

WW.100Y.COM.TW

VCCA



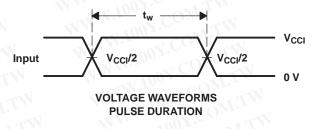
#### PARAMETER MEASUREMENT INFORMATION

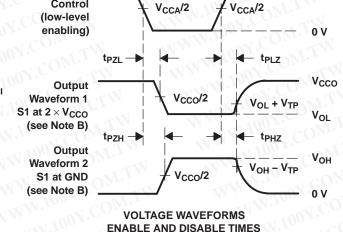


- < 7	- 1
TEST	S1
t <sub>pd</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	2×V <sub>CCO</sub>
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

**LOAD CIRCUIT** 

	V <sub>CCO</sub>	C <sub>L</sub>	RL	V <sub>TP</sub>
	1.2 V	15 pF	2 kΩ	0.1 V
ļ	1.5 V $\pm$ 0.1 V	15 pF	<b>2 k</b> Ω	0.1 V
	1.8 V $\pm$ 0.15 V	15 pF	2 kΩ	0.15 V
d	2.5 V $\pm$ 0.2 V	15 pF	<b>2 k</b> Ω	0.15 V
	3.3 V $\pm$ 0.3 V	15 pF	2 kΩ	0.3 V





Input

V<sub>CCI</sub>/2

V<sub>CCI</sub>/2

V<sub>CCI</sub>/2

V<sub>CCI</sub>/2

V<sub>CCI</sub>/2

V<sub>CCO</sub>/2

V<sub>CCO</sub>/2

V<sub>CCO</sub>/2

V<sub>CCO</sub>/2

V<sub>OL</sub>

VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.

Output Control

- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>0</sub> = 50  $\Omega$ , dv/dt  $\geq$  1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
- I. V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.

Figure 2. Load and Circuit and Voltage Waveforms

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw



勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100v.com.tw

# PACKAGE OPTION ADDENDUM

14-Aug-2010

# **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/ Ball Finish	MSL Peak Temp <sup>(3)</sup>	Samples (Requires Login)
74AVC4T774RGYRG4	ACTIVE	VQFN	RGY	16	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	Request Free Samples
74AVC4T774RSVRG4	ACTIVE	UQFN	RSV	16	3000	TBD	Call TI	Call TI	Request Free Samples
SN74AVC4T774PW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
SN74AVC4T774PWG4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Contact TI Distributor or Sales Office
SN74AVC4T774PWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Request Free Samples
SN74AVC4T774PWRG4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Request Free Samples
SN74AVC4T774RGYR	ACTIVE	VQFN	RGY	16	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	Request Free Samples
SN74AVC4T774RSVR	ACTIVE	UQFN	RSV	16	3000	TBD	Call TI	Call TI	Request Free Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and



# PACKAGE OPTION ADDENDUM

WW.100Y.COM.TW

14-Aug-2010

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

WWW.100Y.COM.T

WW.100Y.COM.TW

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

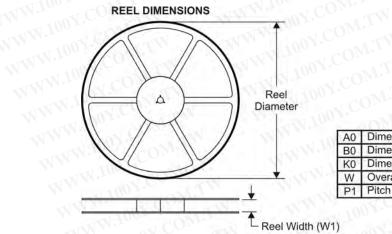
M-MM.100A.COW.

WWW.100Y.COM.TW

# PACKAGE MATERIALS INFORMATION

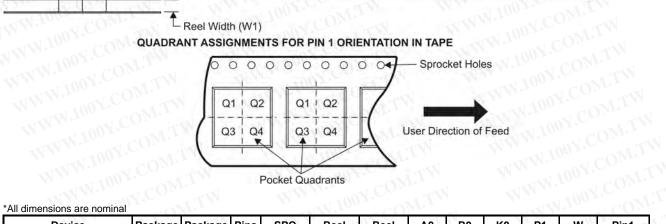
WWW.100Y.COM.TW www ti com 31-Jul-2010

# TAPE AND REEL INFORMATION



#### TAPE DIMENSIONS **★** K0 **★** Φ 0 0 0 0 0 0 0 0 0 → A0 ← Cavity

	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
	Overall width of the carrier tape
	Pitch between successive cavity centers



#### \*All dimensions are nominal

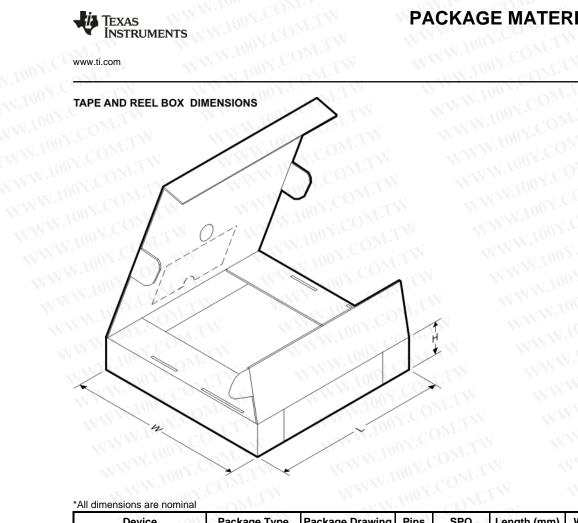
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
N74AVC4T774PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
N74AVC4T774RGYR	VQFN	RGY	16	3000	330.0	12.4	3.8	4.3	1.5	8.0	12.0	Q1

WWW.100Y.COM.TW 特力材料886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw WWW.100Y.COM.TW

WWW.10

WWW.100Y.COM.

100Y.COM.T www ti com 31-Jul-2010



WWW.100

WWW.100Y.COM.

#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
N74AVC4T774PWR	TSSOP	PW	16	2000	346.0	346.0	29.0
N74AVC4T774RGYR	VQFN	RGY	16	3000	346.0	346.0	29.0

WWW.100Y.COM.TW WWW.100Y.COM.TW 勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 WWW.100 Y.COM.TW Http://www.100y.com.tw WWW.100Y.COM.TW

WW.100Y.COM.TW

COM.TW

COM.TW

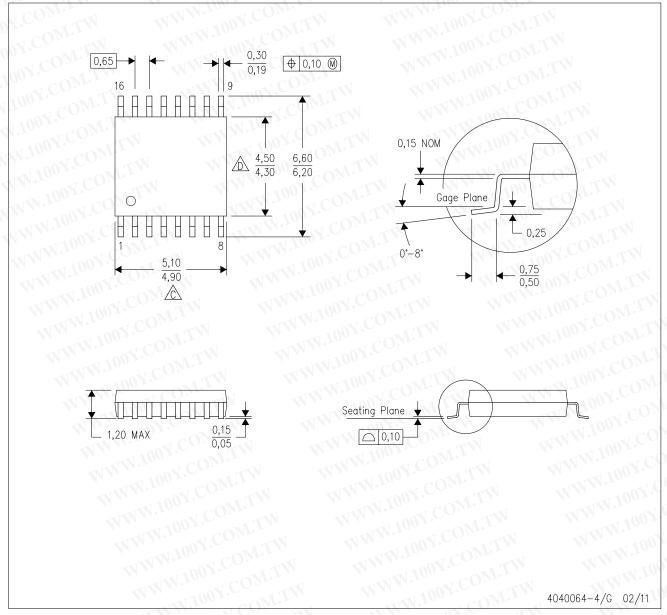
勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787

Http://www.100y.com.tw

PW (R-PDSO-G16)

W.100Y.COM.TW

PLASTIC SMALL OUTLINE



NOTES:

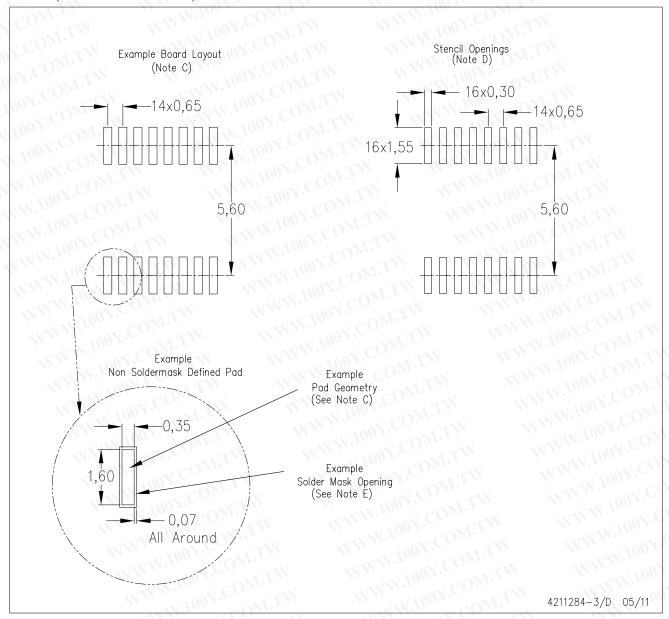
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
- This drawing is subject to change without notice.
  - Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side. WWW.100Y.COM.TW
- E. Falls within JEDEC MO-153



Http://www.100y.com.tw

# PW (R-PDSO-G16)

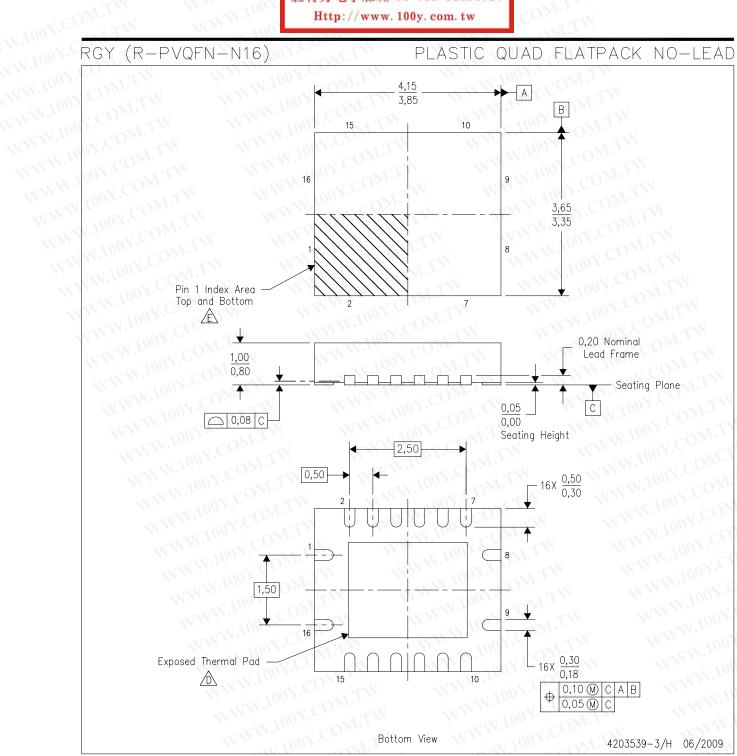
# PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





- NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. QFN (Quad Flatpack No-Lead) package configuration.
  - The package thermal pad must be soldered to the board for thermal and mechanical performance.

    See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
  - Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
  - F. Package complies to JEDEC MO-241 variation BB.



勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

# THERMAL PAD MECHANICAL DATA

W.100Y.COM.TW RGY (R-PVQFN-N16)

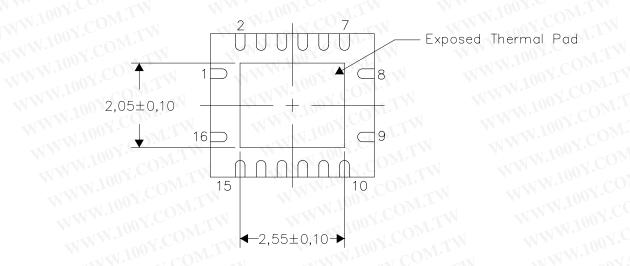
QUAD FLATPACK NO-LEAD

#### THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

WWW.100Y.COM.T Exposed Thermal Pad Dimensions WWW.100Y.COM.

WWW.100X.CO2 4206353-3/M 02/11

WWW.100Y.COM.

A. All linear dimensions are in millimeters

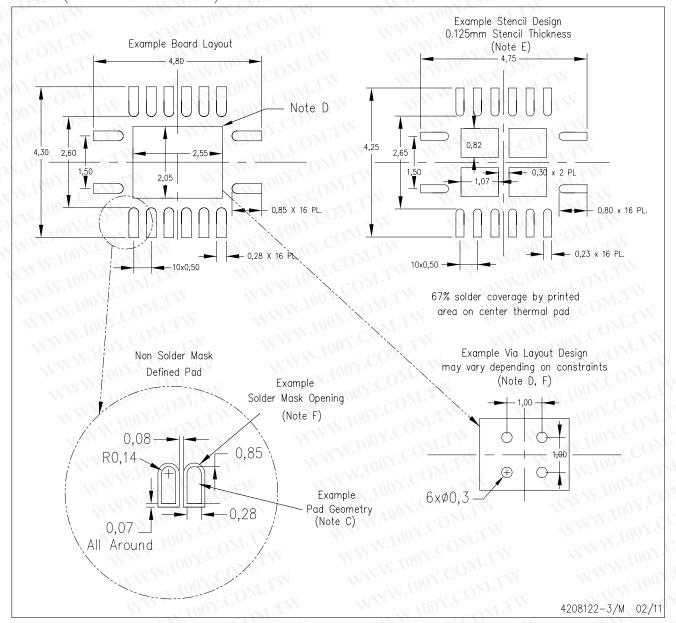


WWW.100Y.COM.

Http://www.100y.com.tw

RGY (R-PVQFN-N16)

# PLASTIC QUAD FLATPACK NO-LEAD



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <a href="https://www.ti.com">http://www.ti.com</a>.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.



WWW.100Y.COM

4207974/C

10/2007

W.100Y.COM.TW Http://www. 100y. com. tw RSV (R-PQFP-N16) PLASTIC QUAD FLATPACK 2,65 2,55 В 12 11 10 13 14 1,85 1,75 15 16 Pin 1 Index Area 0,55 0,45 0,13 Nominal Lead Frame Seating Plane 0,05 С 0,05 C 0,00 Seating Height 1,20 0,40 16 15 1,20 Pin 1 Identifier 14 0,10 X 45° 11 10 12 9 0,15 0,07 M C A B Ф 0,05 (M) C

NOTES: All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

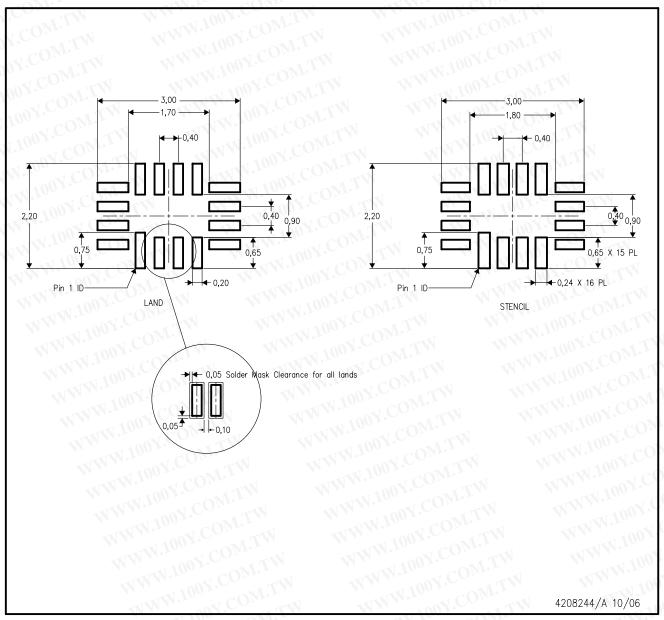
- В. This drawing is subject to change without notice.
- QFN (Quad Flatpack No-Lead) package configuration.
- WWW.100Y.COM.TW This package complies to JEDEC MO-288 variation UFHE, except minimum package thickness.



Bottom View

# RSV (R-PQFP-N16)

W.100Y.COM.TW



- NOTES: A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - D. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.
  - E. Maximum stencil thickness 0,127 mm (5 mils). All linear dimensions are in millimeters.
  - F. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - Side aperture dimensions over-print land for acceptable area ratio > 0.66. Customer may reduce side aperture dimensions if stencil manufacturing process allows for sufficient release at smaller opening.



#### IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

**Applications** 

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

**Products** 

RF/IF and ZigBee® Solutions www.ti.com/lprf

		- 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	
Audio	www.ti.com/audio	Communications and Telecom	www.ti.com/communications
Amplifiers	amplifier.ti.com	Computers and Peripherals	www.ti.com/computers
Data Converters	dataconverter.ti.com	Consumer Electronics	www.ti.com/consumer-apps
DLP® Products	www.dlp.com	Energy and Lighting	www.ti.com/energy
DSP	dsp.ti.com	Industrial	www.ti.com/industrial
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Security	www.ti.com/security
Logic	logic.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Power Mgmt	power.ti.com	Transportation and Automotive	www.ti.com/automotive
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com	Wireless	www.ti.com/wireless-apps

TI E2E Community Home Page <u>e2e.ti.cor</u>

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2011, Texas Instruments Incorporated

> 勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw